

Order Numbers:

ORDER NUMBERS	LEAD-FREE ROHS COMPLIANT PACKAGE TYPE / SIZE	SD/MMC	xD	MS/ MS PRO/ MS PRO-HG	OPERATING TEMPERATURE
USB2240-AEZG-XX	36 QFN 6 x 6 x 0.5 mm	✓	✓	✓	0°C to 70°C
USB2240i-AEZG-XX		✓	✓	✓	-40°C to 85°C
USB2241-AEZG-XX		✓		✓	0°C to 70°C
USB2241i-AEZG-XX		✓		✓	-40°C to 85°C
USB2242-AEZG-XX				✓	0°C to 70°C
USB2242i-AEZG-XX				✓	-40°C to 85°C
USB2244-AEZG-XX		✓			0°C to 70°C
USB2244i-AEZG-XX		✓			-40°C to 85°C

**“XX” in the order number indicates the internal ROM firmware revision level.
Please contact your SMSC sales representative for more information.**

**This product meets the halogen maximum concentration values per IEC61249-2-21
For RoHS compliance and environmental information, please visit www.smSC.com/rohs**

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Overview

The SMSC USB224x is a flash media card reader solution fully compliant with the USB 2.0 specification. All required resistors on the USB ports are integrated into the device. This includes all series termination resistors on D+ and D– pins and all required pull-down and pull-up resistors. The over-current sense inputs for the downstream facing ports have internal pull-up resistors.

Hardware Features

- Single chip flash media controller in low pin count 36-pin QFN, lead-free RoHS compliant package
- Commercial temperature products support 0°C to +70°C: USB2240/41, USB2242 and USB2244
- Industrial temperature products support -40°C to +85°C: USB2240i/41i, USB2242i and USB2244i
- Up to 8 GPIOs
 - Configuration and polarity for special function use such as LED indicators, button inputs, and power control to memory devices
 - The number of actual GPIOs depends on the implementation configuration used
- One GPIO available with up to 200 mA drive and “fold-back” short circuit protection
- 8051 8-bit microprocessor
 - 60 MHz - single cycle execution
 - 64 KB ROM | 14 KB RAM
- Supports a single external 3.3 V supply source; internal regulators provide 1.8 V internal core voltage for additional bill of materials and power savings

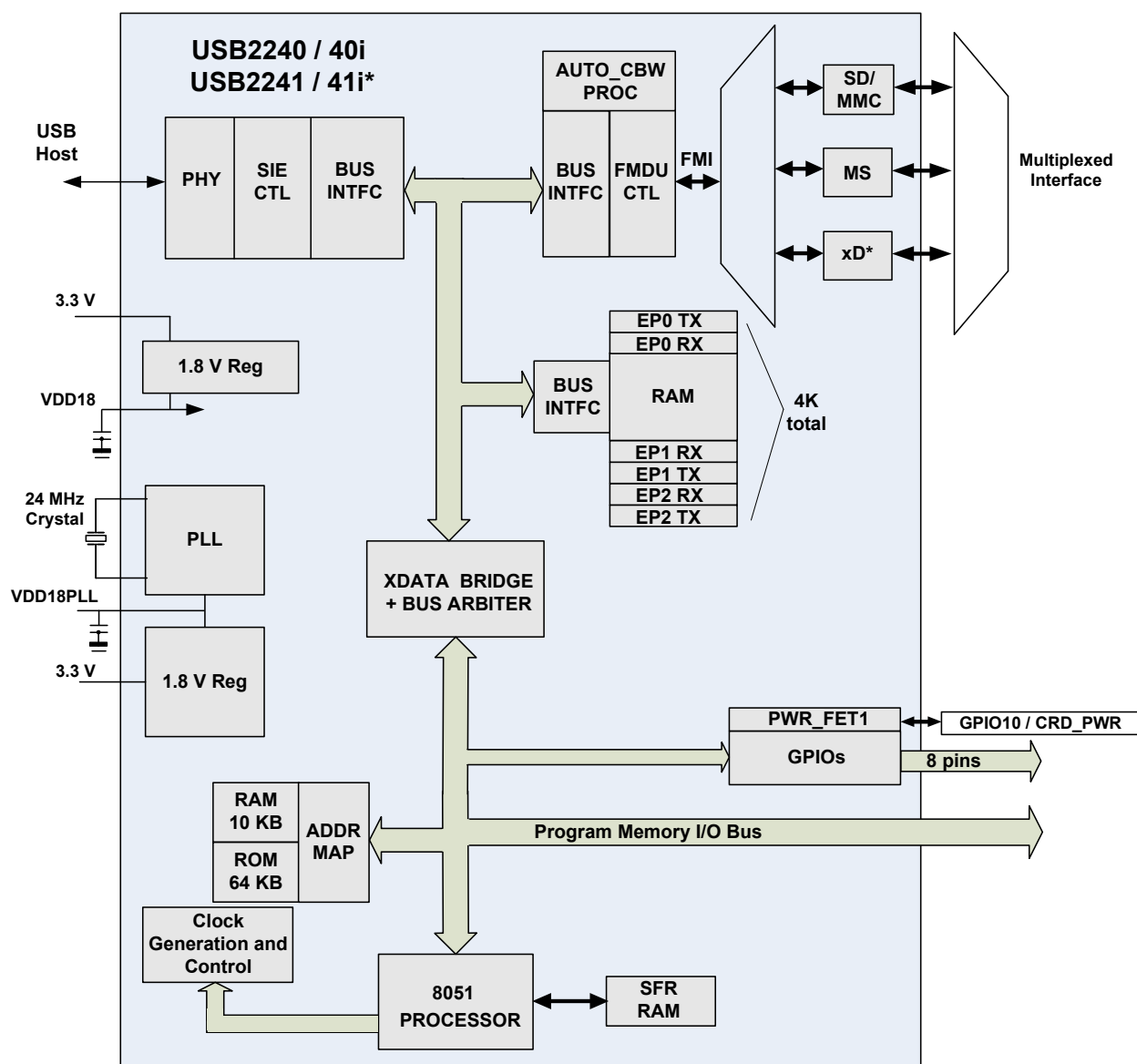
Compliance with the following flash media card specifications:

- Secure Digital 2.0
 - HS-SD and SDHC
 - TransFlash™ and reduced form factor media
- MultiMediaCard 4.2
 - 1/4/8 bit MMC
- Memory Stick 1.43
- Memory Stick Pro Format 1.02
- Memory Stick Pro-HG Duo Format 1.01
 - Memory Stick, MS Duo, HS-MS, MS Pro-HG, MS Pro
- Memory Stick Duo 1.10
- xD-Picture Card 1.2

Software Features

- If the OEM is using an external EEPROM, the following features are available:
 - Customizable vendor, product, language, and device ID's
 - 12-hex digits maximum for the serial number string
 - 28-character manufacturer ID and product strings for the flash media reader/writer
 - LED blink interval or duration

Block Diagrams



NOTE: xD-Picture Card is not applicable to USB2241/41i.

Figure 1 USB2240/40i/41i/41i Block Diagram

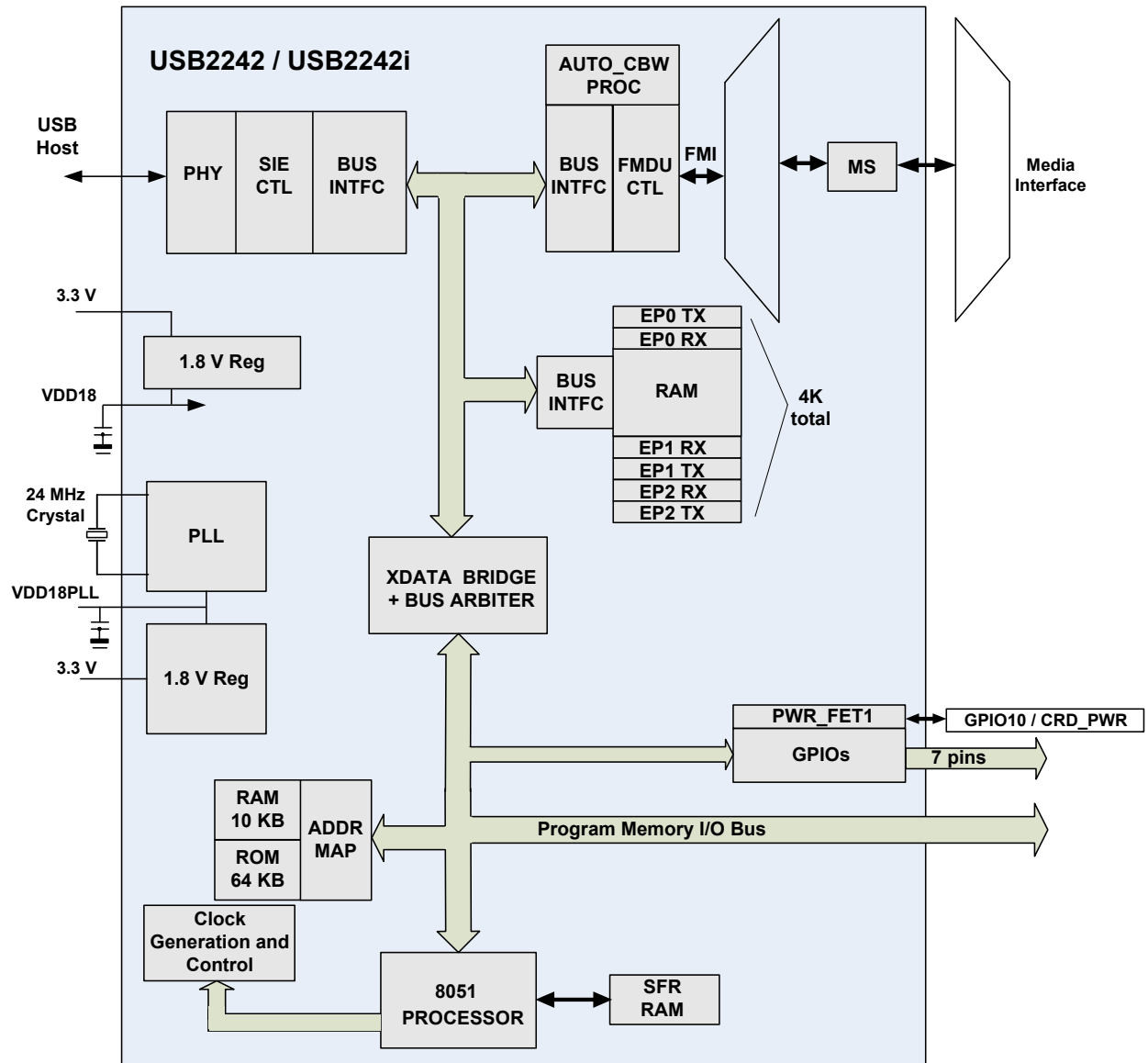


Figure 2 USB2242/42i Block Diagram

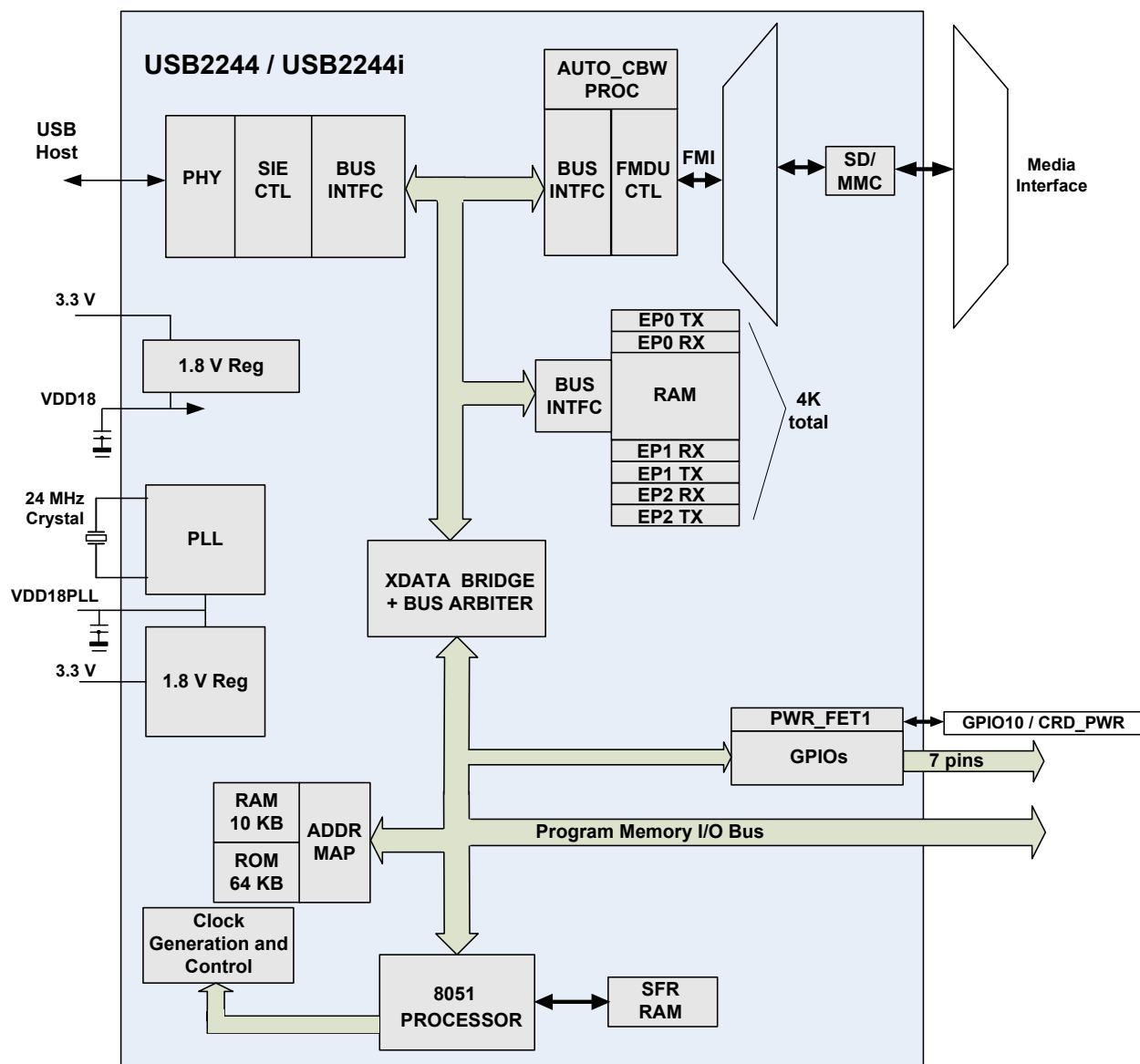


Figure 3 USB2244/44i Block Diagram

Package Outline

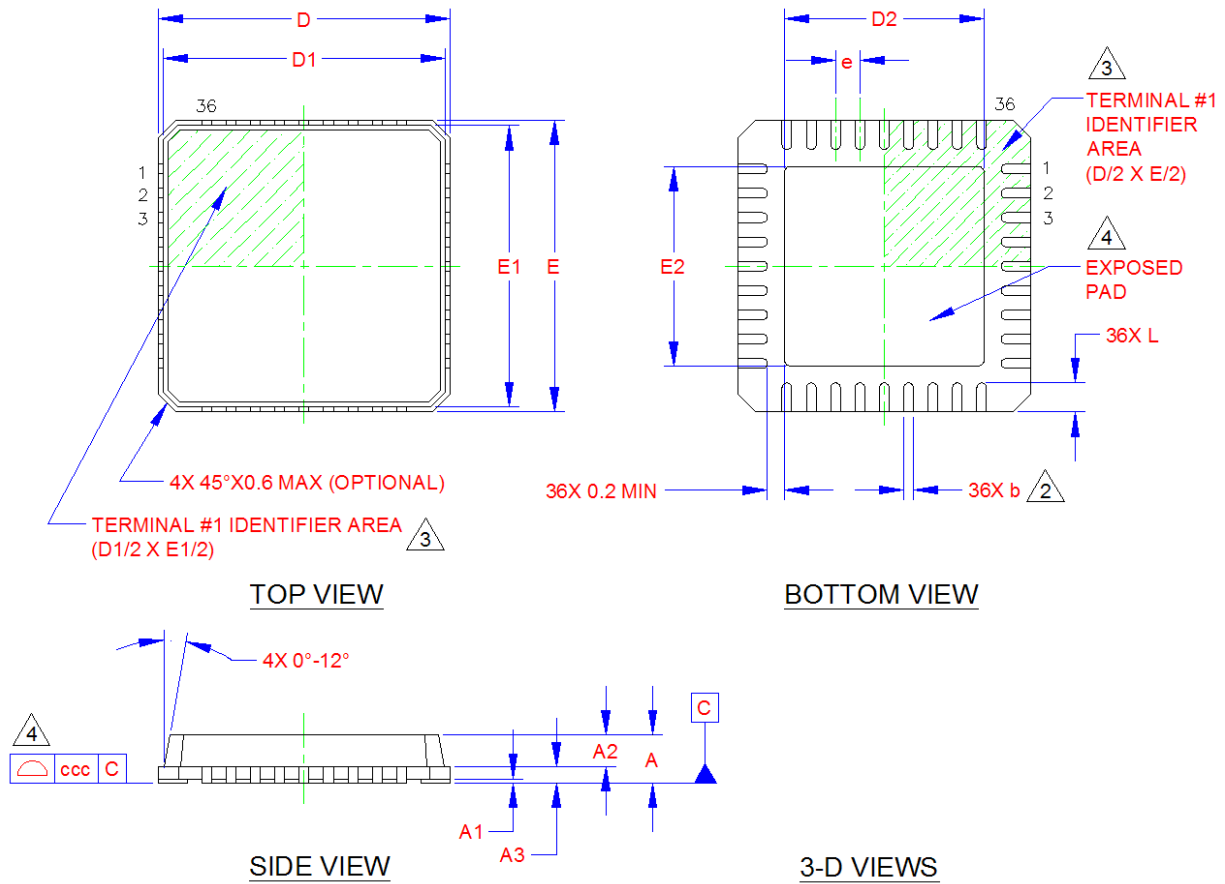


Figure 4 USB224x 36-QFN, 6x6 mm Body, 0.5 mm Pitch

Table 1 Package Parameters

SYMBOL	MIN	NOMINAL	MAX	NOTE	REMARKS
A	0.80	~	1.00	-	Overall Package Height
A1	0	0.02	0.05	-	Standoff
A2	0.60	~	0.80	-	Mold Thickness
A3	0.20 REF			-	Leadframe Thickness
D/E	5.85	6.00	6.15	-	X/Y Overall Body Size
D1/E1	5.55	~	5.95	-	X/Y Mold Cap Size
D2/E2	4.00	4.10	4.20	2	X/Y Exposed Pad Size
L	0.50	0.60	0.75	-	Terminal Length
b	0.18	0.25	0.30	2	Terminal Width
e	0.50 BSC			-	Terminal Pitch

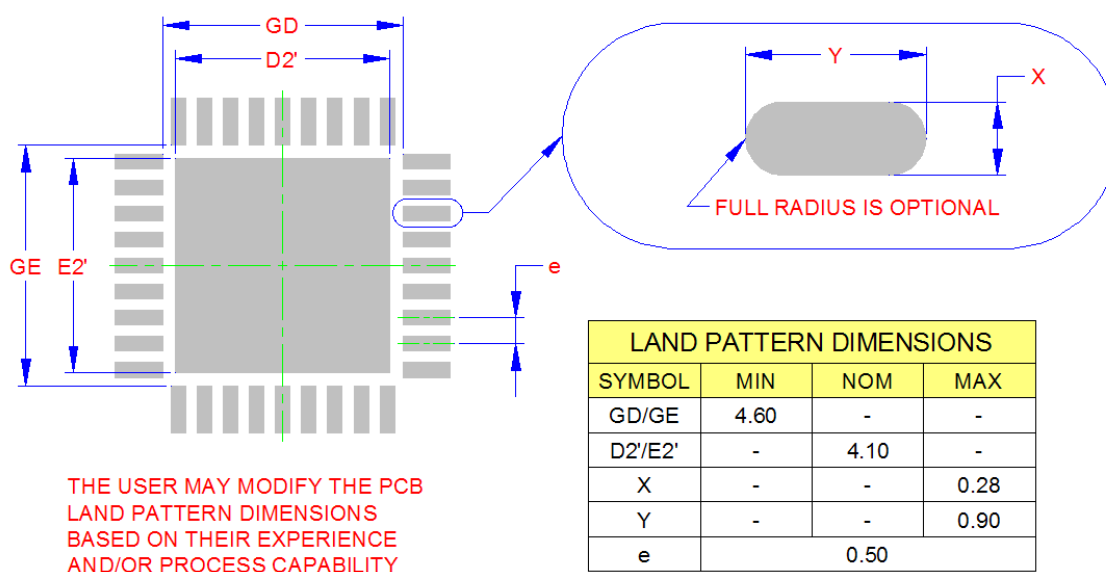
Note 1 All dimensions are in millimeters.

Note 2 Position tolerance of each terminal and exposed pad is ± 0.05 mm at maximum material condition.

Note 3 Dimension “b” applies to plated terminals and is measured between 0.15 mm and 0.30 mm from the terminal tip.

Note 4 Details of terminal #1 identifier are optional but must be located within the area indicated.

Note 5 Coplanarity zone applies to exposed pad and terminals.



RECOMMENDED PCB LAND PATTERN

Figure 5 Additional Package Information and Notes